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Chi Weon Yoon	Science and Technology Internal Address:
Additional name(s) of conveying party(ies) attached?	Yes XX No 373-1 Kusong-dong, Yusong-ku,
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## Assignment

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is , the undersigned, hereby acknowledged, YOO, Hoi Jun YOON, Chi Weon

Hereby sell, assign and transfer to	KOREA ADVANCED INSTITUTE OF SCIENCE AND TECHNOLOGY
	(Representative: CHOI, Duk-In)
a corporation of having a place of business at	373-1 Kusong-dong, Yusong-ku, 305-701 Taejon-si, Republic of Korea

its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled PIPELINE STRUCTURE OF MEMORY FOR HIGH-FAST ROW-CYCLE

(Attorney's Docket No.: 01-257)

, and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignce may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignce, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignce, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignce, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

	YOO, Hoi Jun (LS.)
Date. May. 21, 2001	(L.S.)
Date	/ • · · · · · · · · · · · · · · · · · ·
Date	YCON, Chi Weon
Date	YCON, Chi Weon (L.S.)
Date	(L.S.)
Date	
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